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Broader context

Despite achieving high efficiencies, perovskite solar cells struggle with long-term stability, *e.g.* due to halide migration under illumination and moisture. We reveal that the degradation of the hole-transport layer (HTL) and related degradation by-products into the perovskite leads to its transformation from a crystalline phase to an undesirable amorphous phase. To address this issue, we deposited alumina on the perovskite surface as a compact and conformal interfacial layer using atomic layer deposition. We demonstrate that this protective layer acts as a dual-purpose diffusion barrier. It effectively blocks the ingress of degraded by-products into the perovskite and the egress of halide ions from the perovskite to the HTL, resulting in enhanced stability under operating conditions. This highlights the importance of understanding layer-by-layer degradation under operating conditions to fully elucidate the mechanisms of complete cell degradation. Such insights are crucial for advancing the understanding, development and commercialization of perovskites.

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Mitigating the amorphization of perovskite layers

by using atomic layer deposition of alumina⁺

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Atomic layer deposition of aluminum oxide (ALD-Al₂O₃) layers has recently been studied for stabilizing perovskite solar cells (PSCs) against environmental stressors, such as humidity and oxygen. In addition, the ALD-Al₂O₃ layer acts as a protective barrier, mitigating pernicious halide ion migration from the perovskite towards the hole transport interface. However, its effectiveness in preventing the infiltration of ions and additives from the hole-transport layer into perovskites remains insufficiently understood. Herein, we demonstrate the deposition of a compact ultrathin (\sim 0.75 nm) ALD-Al₂O₃ layer that conformally coats the morphology of a triple-cation perovskite layer. This promotes an effective contact of the hole transporter layer on top of the perovskite, thereby improving the charge carrier collection between these two layers. Upon systematically investigating the layer-by-layer structure of the PSC, we discovered that ALD-Al₂O₃ also acts as a diffusion barrier for the degraded species from the adjacent transport layer into the perovskites to an undesired amorphous phase. Consequently, the dual functionality (*i.e.*, enhanced contact and diffusion barrier) of the ALD-Al₂O₃ protection enhanced the

device performance from 19.1% to 20.5%, while retaining 98% of its initial performance compared to <10% for pristine devices after 1500 h of outdoor testing under ambient conditions. Finally, this study

deepens our understanding of the mechanism of ALD-Al₂O₃ as a two-way diffusion barrier, highlighting

the multifaceted role of buffer layers in interfacial engineering for the long-term stability of PSCs.

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Introduction

Organic–inorganic halide perovskite solar cells (PSCs) have emerged as a promising thin-film photovoltaic technology, with a current record power conversion efficiency (PCE) of > 26%.^{1,2} However, their long-term stability under the operating conditions hinders commercialization.^{3,4} The interfaces in a multilayer stack act as a source of defects, leading to intrinsic instabilities.^{5–7} Various chemical and mechanical passivation techniques, including organic salts, polymers, and laser polishing, effectively mitigate these defects and increase device performance and stability.^{8–12} However, solvent-based post-treatment processes lack uniform coverage on a larger scale, potentially impacting long-term stability.^{13–15}

To overcome these challenges, atomic layer deposition (ALD) has been employed as a strategy for depositing compact thin metal oxides (sub-10 nm) as protective layers, particularly in microelectronics and photovoltaic industries.¹⁶⁻¹⁸ In the case of perovskites, several studies have reported the successful application of ALD of alumina (Al₂O₃) on perovskites at higher temperatures (>100 °C).^{19–22} This process involves depositing ALD-Al₂O₃ directly onto perovskites, such as methylammonium lead iodide (MAPbI₃), resulting in an improved PCE of \sim 18% with improved stability, maintaining 60% of its initial performance after 60 days in an ambient atmosphere with a relative humidity (R.H.) of 40–70%.²³ Moreover, Kot et al. utilized room-temperature ALD (RT-ALD) deposition on MAPbI3 to avoid the effect of thermal stress on the perovskite and showed an increase in device performance and stability with an ALD-Al2O3 overlayer on top of the perovskite film over time.^{24,25}

Such notable improvements in device stability are often attributed to the suppression of halide ion migration from MAPbI₃ perovskites towards the hole-transport layer (HTL) or the ingress of H₂O molecules into perovskites through the ALD-Al₂O₃ layer.^{26–28} However, these studies with ALD-Al₂O₃ passivation focus on "half-cell configurations" of inherently unstable perovskites, leaving the effect of the subsequently deposited charge-transport layer underexplored.^{19,26,29} Interestingly, the use of additives in spiro-OMeTAD in record-efficiency cells may result in undesirable products that percolate into the perovskite absorber, accelerating degradation and photoinstability.^{2,30–32} Thus, the protective layer stabilizes against the environment as well as against the adjacent layers.^{33,34}

Despite these promising examples, there is limited evidence in literature on the conformal coverage of (<2 nm) ALD layers. In this study, using conductive atomic force microscopy (c-AFM), we demonstrated the uniform coverage of a ~0.75 nm thin ALD-Al₂O₃ layer on top of a standard triple-cation perovskite, including its facets. This homogeneous coverage resulted in a PCE of 20.5% (from 19.1%) without modifying the bulk.^{35,36} The devices were subjected to shelf-aging (<10% R.H.) for 180 days, followed by 1000 min of maximum power point tracking (MPPT) under ambient conditions (>60% R.H.) to evaluate the shelf and operational stability. The unencapsulated devices with the ~0.75 nm ALD layer retained 75% of the initial PCE, whereas the control devices retained only 10% of the initial PCE. Furthermore, when conducting outdoor stability tests under ISOS-O-2 protocol for 1500 h, the ALD-protected device maintained >98% of its initial efficiency compared to <10% for the control devices. We also systematically investigated the role of ALD-Al₂O₃ in enhancing the intrinsic stability of perovskite, with and without the spiro-OMeTAD overlayer. We observed that the ALD-Al₂O₃ layer improved the contact of the spiro-OMeTAD layer with the perovskite layer, thus mitigating shunting pathways. This compact barrier layer also inhibited the diffusion of byproducts from spiro-OMeTAD degradation under operating conditions into the perovskite. Thus, our study highlights the bifunctional nature of the interfacial diffusion barrier, both as a protection against penetration by extrinsic stressors and in preventing intrinsic outgassing from the active layer.

Results and discussion

Al₂O₃ barrier layers of various thicknesses were deposited by precisely controlling the number of ALD cycles deposited on a triple-cation (using Cs, MA and formamidinium (FA)) perovskite composition at room temperature. More details on fabrication and characterization can be found in the Experimental Section. The ALD-Al₂O₃ during deposition was monitored using *in situ* spectroscopic ellipsometry (SE), as shown in Fig. 1a. After the first few cycles (denoted as "I" for the "initial" ALD growth process), the thickness starts to increase linearly resulting in a "steady" growth regime (II).

In the inset of Fig. 1a, a sudden increase in the thickness is observed after the first ALD cycle, as TMA and H2O react to form alumina on top of the perovskite. However, with subsequent ALD cycles, the growth follows a meandering behavior, as the growth is assumed to be island-based because of the presence of various adsorption sites on the perovskite surface or steric hindrance.37 This can be described as the "initial regime" (I) until the perovskite layer is fully covered by the ALD process. From Fig. 1a, it can be assumed that after 10-14 cycles, the linear growth of alumina starts on the perovskite with a conformal thickness of <1 nm. We note that have also obtained a thickness of \sim 35.24 nm after 600 ALD cycles on a clean silicon wafer to obtain a growth cycle of 0.057 nm per cycle, see Fig. S1 (ESI⁺). Thus, in this study, we have assigned a thickness of ~ 0.75 nm for the ALD-Al₂O₃ thin film after 14 ALD cycles at room temperature.

To ensure the deposited ALD layer's conformity and quality, we first investigated a ~ 5 nm thick alumina layer on top of the perovskite. In Fig. 1b, we show transmission electron microscopy (TEM) images of the cross-section showing a homogeneous coating of alumina on top of the perovskite surface *via* ALD, without any discernible discontinuities, even on a larger scale. Furthermore, selected area electron diffraction (SAD) data were collected in these two distinct regions: perovskite and ALD-Al₂O₃, as shown in Fig. 1b. The SAD pattern from the perovskite region showed randomly overlapping rings with bright spots, indicating the presence of a polycrystalline material. The diffraction patterns from the ALD-Al₂O₃ spot



Fig. 1 (a) Variation in stack thickness (ITO/Perovskite/ALD-Al₂O₃) with the number of ALD cycles measured by *in situ* spectroscopic ellipsometry. Topleft inset: Device stack. Bottom-right inset: magnified view of the first 30 cycles with two growth modes: initial (I) and steady growth (II). (b) Crosssectional transmission electron microscopy (TEM) image of a ~5 nm ALD-coated perovskite on a polished silicon substrate. A 200 nm layer of Pt was deposited to prevent damage to the ALD layer during focused ion beam milling. Insets show selected area diffraction patterns of Al₂O₃ (amorphous) and perovskite (crystalline). (c) 3D conductive atomic force microscopy (c-AFM) images of the uncoated and ALD-0.75nm films with the current contrast overlaid on the topological images collected over the same area, revealing the microstructure-specific response in the dark at 400 mV. The scale was the same for the uncoated and ALD-0.75nm films and fixed from 16 pA to 18 pA. (d) Current comparison of the perovskite film surface extracted from c-AFM image before and after ~ 0.75 nm of ALD-Al₂O₃.

show a ring pattern that is more diffused and continuous, confirming the presence of an amorphous phase, which is consistent with previous reports.^{38,39} For ALD film crystallization, typically, a post-annealing treatment using significantly higher temperatures (>200 °C) is required.⁴⁰ We posit that amorphous Al₂O₃ can also act as a passivation layer, as previously reported in literature.^{41,42} Fig. S2 and S3 (ESI†) show the individual elemental mapping and energy-dispersive X-ray (EDX) spectra displaying the uniform distribution of ALD-Al₂O₃ on the top of perovskite.

Further, we also performed reflection electron energy loss spectroscopy (REELS) to determine the bandgap (E_g) of the ultrathin ALD-2nm film on perovskite. The spectrum of the amorphous ALD-Al₂O₃ shows a shoulder at 0.71 eV and a broad loss feature at the onset of 3.27 eV in Fig. S4 (ESI†). This value is in close agreement with the previously reported value of ultrathin amorphous alumina (3.2 eV).⁴³ Additionally, unlike stoichiometric and well-ordered crystalline alumina, our measurement also shows the distribution of tail states in the "forbidden" energy gap (shaded in orange). We associate the absence of sharp edges at the onset with the sub-bandgap electronic defects induced by site disorder and ideal vacancies owing to the amorphous and non-stoichiometric ratio of the ALD-Al₂O₃ layer.

While the coverage of a "thick" ~ 5 nm layer benefits stability, it exacerbates the charge extraction.^{25,44} Therefore,

the alumina layer needs to be sufficiently thick to uniformly cover the surface and, at the same time, sufficiently thin to have as low a series resistance as possible. To this end, we deposited \sim 0.75 nm (referred to as "ALD-0.75nm") and \sim 2 nm (ALD-2nm) alumina on bare perovskite to ensure maximum perovskite coverage. In Fig. 1c, we map and correlate the local resistive dark current along with the topographic features of the underlying perovskite using conductive atomic force microscopy (c-AFM). Large variations in the current profile of the pristine (referred to as "uncoated") perovskite film can be observed with the perovskite facets owing to the different orientations of the polycrystalline thin films.⁴⁵ The ALD-0.75nm has weakened the conductivity of the perovskite film and only some grain tips (from roughness) were not covered. In Fig. 1d, we observed that ALD-0.75nm reduces the total average current by \sim 0.20 pA, and the conductivity spread has been minimized, highlighting a uniform coverage of the ALD layer on the perovskite surface. For ALD-2nm, the perovskite was completely covered, including the facets and tips, as shown in Fig. S5 (ESI[†]). The individual topography maps, along with the current values, are shown in Fig. S6-S8 (ESI[†]). Additionally, masking the current value has provided us a coverage area of 87.46% after ~ 0.75 nm of ALD coverage and 98.03% after 2 nm of ALD coverage. These c-AFM results confirm that an ultrathin ALD layer covers most of the

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perovskite facets, including the grain boundaries, as also suggested by our *in situ* spectroscopic ellipsometry results in Fig. 1a. Such a large-area surface coverage uniformity of an ultrathin interfacial layer is noteworthy as conventional solventbased organic passivation layers tend to accumulate in the dips of the perovskite and passivate only the grain boundaries, as shown by Martins *et al.*⁴⁶ However, full coverage by ALD-2nm comes at the cost of a significant loss in the transfer of photogenerated current, as shown in Fig. S19 (ESI†). Thus, in the following sections, we focus on ALD-0.75nm.

Next, the role as barriers of these uniform ALD-0.75nm layers on perovskite were studied in the "half-cell" configuration (without overlying HTL). Fig. 2a shows the top-view scanning electron microscopy (SEM) images of the as-prepared ("Fresh") uncoated and ALD-0.75nm coated perovskites. The surface morphology of the ALD-0.75nm perovskite was comparable to that of the uncoated perovskite, indicating that the perovskite remained undamaged by the room-temperature ALD process. This contrasts with the reports for MAPbI₃ and $MA_{\nu}FA_{(1-\nu)}Pb(IBr)_3$, where a porous degradation pattern of >40 nm was observed.^{26,27} In Fig. 2b, we note that both the ALD-0.75nm and uncoated films started to degrade and developed pinholes under exposure to 1 sun illumination for 1000 min in an atmosphere of >50% R.H. ("Aged"). The damage to the uncoated perovskite was much more severe throughout the surface, including the grain boundaries and also within the grains (highlighted with red circles). We posit that this is because of the possible escape of volatile organic gases from residual solvents or perovskite decomposition upon light and moisture degradation, as previously reported.47-49 For ALD-0.75nm, fewer pinholes were observed within the grains, indicating that the protective alumina barrier reduced the ingress of O₂ and H₂O.⁵⁰ Upon light degradation, the absorbance in Fig. 2c also

decreased for both the uncoated and ALD-0.75nm perovskites, showing that direct light exposure in ambient conditions accelerates decomposition, as confirmed by the SEM images. Interestingly, in the inset of Fig. 2c, the uncoated film did not show any clear absorption onset around its band gap, whereas the ALD-0.75nm maintains a much sharper absorption onset, indicating that the perovskite retained its original absorber quality.

The X-ray diffraction (XRD) measurements for the fresh ALD-0.75nm and uncoated perovskite were similar (see Fig. S9, ESI^{\dagger}). Fig. 2d shows the XRD reflections at 14.3° for the uncoated and ALD-0.75nm perovskites after light aging. The (001) reflection of the ALD-coated perovskite was almost twice that of the uncoated samples under constant light illumination in an ambient atmosphere (Fig. S10, ESI⁺). We also note that the PbI₂ peak at 12.7° is not as pronounced upon light degradation, even for the uncoated triple-cation perovskite, as it was observed for the MAPbI3 and MAyFA(1-y)Pb(IBr)3 solar cells.^{26,51} Such observations underline the importance of the perovskite composition and its reactivity towards similar interfacial treatments, producing contrasting results. Based on these experiments, in Fig. S11 (ESI⁺), we also provide a possible growth mechanism of ALD-Al₂O₃ on top of FA-dominated perovskite using X-ray photoelectron spectroscopy (XPS). Thus, together with the morphology, crystallinity, and optical properties, it was shown that the ALD-protected perovskite film exhibited a slower intrinsic degradation as atmospheric gases were blocked, e.g., O₂ and H₂O (even in the presence of light).

In addition, to study the role of alumina as a barrier layer in a back electrode-free device, the spiro-OMeTAD as an HTL was deposited on the uncoated and ALD-0.75nm perovskite films, as shown in Fig. 3a. We performed the aging experiments as mentioned above, *i.e.*, under light and ambient atmospheric



Fig. 2 (a) and (b): Top-view of scanning electron microscopy (SEM) images. (c) Normalized absorbance (Inset: The enlarged region around the absorption onset) of the uncoated and ALD-0.75nm films before (Fresh) and after a light soaking test for 1000 min in the ambient atmosphere of > 50% R.H. (Aged). (d) X-ray diffraction (XRD) pattern of the uncoated and ALD-0.75nm coated perovskite films after aging.



Fig. 3 (a) Schematic of the ALD-0.75nm perovskite with a spiro-OMeTAD layer under aging conditions. (b) Optical images. (c) X-ray photoelectron spectra of carbon 1s (C1s) and fluorine 1s (F1s) core levels. (d) X-ray diffraction patterns. (e) Normalized time-of-flight secondary ion mass spectrometry depth profile of individual ions representing spiro-OMeTAD (OMe), CsMAFA perovskite (Pb, MA, FA, I), ITO (Sn), and Al_2O_3 (Al) layers of the uncoated and ALD-0.75nm films along with the spiro-OMeTAD layer fresh and after light aging under ambient conditions (>50% R.H.).

conditions (>50% R.H.) for 1000 min. In Fig. 3b, the uncoated film with spiro-OMeTAD turned towards a white, milky color rather than the expected yellow color of the PbI₂ phase, which is the commonly reported degradation product of perovskite.⁵² On the other hand, the ALD-0.75nm sample showed no visible signs of aging. This observation underscores that the role of the ALD-0.75nm barrier depends on the overlying layer. Moreover, this observation also underlines the degradative role of hygroscopic dopants, such as Li-TFSI salt in spiro-OMeTAD.³⁰

To understand the chemical changes in spiro-OMeTAD in a full device during long-term operation, we performed in-operando near-ambient pressure X-ray photoelectron spectroscopy (NAP-XPS) measurements on the perovskite/(ALD-Al₂O₃)/spiro-OMeTAD stack. The C1s and F1s spectra have shifted to higher binding energy (B.E.) by ~ 0.3 and ~ 0.5 eV upon light illumination in the uncoated and ALD-0.75nm stack, as shown in Fig. 3c. The higher shift in the B.E. is consistent with the higher photovoltages in the ALD-0.75nm perovskite.53,54 The spectra of all the other elements are shown in Fig. S12 (ESI[†]). Further, to observe the chemical changes on the spiro-OMeTAD surface, we applied accelerated aging conditions, *i.e.*, illumination at 80 °C, 1 mbar H₂O and O₂ atmosphere. The C1s and F1s spectra shift back to their respective dark peaks (indicated by the smaller arrows in Fig. 3c) for the ALD-0.75nm films, even under illumination. This confirms the loss in surface photovoltage due to chemical changes in the spiro-OMeTAD under light and moisture, independent of the buried interface.^{55,56} Interestingly, the C1s and F1s spectra in the uncoated sample moved to an even lower binding energy (shown by the larger arrow to the right in Fig. 3c, which might have been caused by the chemical reduction of spiroOMeTAD owing to a damaged interface in the unencapsulated sample.⁵⁷ Additionally, the $I3d_{5/2}$ peak for both the uncoated and ALD-0.75nm is substantially low (compared to fresh samples) on the spiro-OMeTAD surface, even upon aging under light and moisture (see Fig. S13, ESI†).

XRD measurements were performed on the above-mentioned fresh and aged films to reveal the changes in the perovskite/(ALD-0.75nm)/spiro-OMeTAD bulk structural properties. The XRD measurement of the uncoated sample in the presence of spiro-OMeTAD showed a PbI₂ peak before light aging, unlike the ALD-0.75nm samples, as shown in Fig. S14 (ESI[†]). This could indicate that the degradation mechanism of perovskite is different in the "half-cell" configuration as compared to that in the presence of spiro-OMeTAD film under aging conditions. Upon light and moisture aging, the perovskite peaks started disappearing in the uncoated sample. Additionally, an increase in the amorphous background is displayed in Fig. 3d. This 100% reduction in the scattering intensity of the uncoated sample indicates the absence of long-range order in the perovskite structure, pointing towards amorphization, as reported by Abate et al.^{58,59} A small peak was observed at 11.6°, while no PbI2 and perovskite peaks were observed in the uncoated sample. This indicates the possible transition of the perovskite to the FAPbI₃-based δ phase containing the MA⁺ cation.^{60,61} In contrast, the ALD-0.75nm sample with spiro-OMeTAD exhibited a dominant perovskite reflection (14.3°) and a small PbI_2 (12.7°) reflection upon aging, which is consistent with the XRD results shown in Fig. 2d. The insertion of the ALD-0.75nm layer significantly suppressed phase transformation.

Time-of-flight secondary ion mass spectrometry (ToF-SIMS) was employed to analyze the chemical distribution within the

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degraded phase of the perovskite layer. In Fig. 3e, for the uncoated device, the overlap of OMe⁺ and Pb²⁺ (indicated in the black arrow) suggests the diffusion of the degraded spiro-OMeTAD components into the perovskite layer, leading to an amorphous phase, as confirmed by the XRD pattern shown in Fig. 3d. In addition, the MA⁺ and FA⁺ signals were reduced drastically, indicating the escape of volatile species through pores of the aged spiro-OMeTAD. The remaining amounts of MA^+ and FA^+ signals, along with Pb^{2+} and I^- towards the perovskite/SnO2 interface, could be related to the photoinactive δ phase of the perovskite as seen in the XRD pattern in Fig. 3d. By inserting an ALD-0.75nm layer between the perovskite and spiro-OMeTAD, the depth profiles could be clearly distinguished from MA⁺ and FA⁺, retaining their composition along with Pb^{2+} and I^- in the perovskite region. Furthermore, the sharp drop in the OMe⁺ concentration from the spiro-OMeTAD towards the perovskite bulk proves the barrier capability of the ultrathin alumina layer under operating conditions. The intensity of the Al³⁺ peaks at the spiro-OMeTAD/perovskite interface and decreases uniformly on both sides, as also observed by Yun et al.62

Next, we explored the effect of the ALD-0.75nm in a full device in the following n-i-p stack: glass/ITO/SnO₂/CsMAFA/ (ALD-0.75nm)/spiro-OMeTAD/Au. First, we shelf-aged the unencapsulated devices for 180 days (<10% R.H.) followed by a maximum power point tracking (MPPT) in an ambient atmosphere (>50% R.H.) for 1000 min. The spatial inhomogeneities in these devices were visualized using electroluminescence (EL) measurements before and after the MPPT aging under ambient conditions. As depicted in Fig. 4a, both samples exhibited high luminescence at the beginning of the current biasing, even saturating the detector. Over time, the uncoated device exhibited a decreased luminescence within 10 s. In contrast, the

ALD-0.75nm device maintained distinct cell edges, indicating a decreased device degradation from the edges, along with an intact cell interface. 63

To compare the EL intensities, a specific area, including only the pixels corresponding to the cell, was selected, and the relative mean EL variation in the area was plotted over time, see Fig. S15 (ESI⁺). After MPPT, the electroluminescence (EL) intensity decreased exponentially for both devices but stabilized for the ALD-0.75nm device after 5 s, as seen in Fig. S15 (ESI⁺). Within 5 s, the uncoated device exhibits a larger fraction of dark regions, as shown in Fig. 4b (top). This may be attributed to the formation of significant shunt pathways because the electron transport layer (ETL) and HTL are in direct contact.⁶⁴ Conversely, the ALD-0.75nm device experienced only a reduction in EL intensity while maintaining the same spatial distribution, even after 5 s. A series of EL images captured at regular intervals for all devices, along with a histogram of pixel intensity, are presented in Fig. S16 (ESI⁺). The formation of degraded phases in the uncoated devices, contributing to the dark areas in the EL image, can also be observed in the optical images from the back side in Fig. S17 (ESI[†]).

This accelerated, non-uniform degradation observed in the EL of the MPPT-aged devices could be attributed to the deterioration of any of the multiple layers within the stack (or a combination thereof). We present cross-sectional SEM images of both the uncoated and ALD-0.75nm devices before and after MPPT in Fig. 4c and d. The cross-sectional image of the uncoated device revealed small voids (highlighted by red circles) between the spiro-OMeTAD/perovskite interface. During MPPT, these voids appeared to increase significantly. Interestingly, perovskite grains, which often go from the bottom to the top, also seem to be less defined at the spiro-OMeTAD/perovskite interface, which may impede carrier photogeneration and transport.⁶⁵ In stark contrast, an ultrathin ALD layer prevents



Fig. 4 (a) and (b):a Electroluminescence (EL) mapping of the uncoated and ALD-0.75nm devices (a) Before MPPT and (b) After MPPT aging. The images were captured while the current was applied. The applied current density of J = 6.25 mA cm⁻² was the same for all the devices. (c) and (d): Cross-sectional SEM images of the uncoated and ALD-0.75nm devices (c) before and (d) after MPPT aging.

the growth of pinholes at the perovskite/spiro-OMeTAD interface, proving a strong contact with the spiro-OMeTAD layer. After MPPT, the perovskite grains remained relatively intact, maintaining a stable charge transport interface.

Of the several PSC degradation mechanisms proposed in literature, we focus on the compact conformal interlayer.⁶⁶ In Fig. 5, we hypothesize that the deposition of ALD-Al₂O₃ on the standard "triple-cation" perovskite may occur as follows. First, it improves the contact with the overlying spiro-OMeTAD HTL. Second, alumina may passivate defect states on the perovskite surface. Third, the ALD layer prevents additional degradation pathways by minimizing the ion migration of the degraded byproducts of spiro-OMeTAD towards the perovskite and ETL. This ion diffusion in the presence of moisture renders the interface permeable, thereby degrading the perovskite.

Determining the exact reaction mechanism of the degraded spiro-OMeTAD species with perovskites is challenging. However, as previously reported, the porosity of the spiro-OMeTAD facilitated the ingress of H_2O and O_2 to degrade organic FA⁺ and MA⁺ molecules from the surface. The degraded triple-cation perovskite turns into a thermodynamically favored, non-photoactive δ -phase of FAPbI₃.⁶⁷ Recently, Correa-Baena *et al.* proposed a degradation mechanism: First, the surface oxidation of iodide ions (I⁻) to iodate (IO₃⁻) occurs (see reaction (1)).

$$I^{-} + \frac{3}{2}O_2 \to IO_3^{-}$$
 (1)

This iodate species transforms the surface PbI_2 to a more thermodynamically favorable one, referred to as $Pb(IO_3)_2^*$, in two steps, reactions (2) and (3).⁵⁹

$$PbI_2^* + 3O_2 \rightarrow Pb(IO_3)_2^*$$
(2)

$$Pb(IO_3)_2^* \rightarrow Pb(IO_3)_2 + V_{PbI_2}$$
(3)

Uncoated

Glass/ITO

Glass/ITO

Ambient Air

(O2, N2)

Spiro-OMeTAD

where V_{PbI_2} is a PbI₂ vacancy. Further, this lead iodate complex reacts with the OMe⁺ group of spiro-OMeTAD to form an amorphous material. The proposed degradation path is confirmed in our results by the absence of PbI₂ peaks in the XRD pattern of the uncoated sample (see Fig. 3c). Time-of-flight secondary ion mass spectrometry (ToF-SIMS) results showed that the functional group from the spiro-OMeTAD layer migrated into the perovskite. We posit that OMe⁺ is much smaller in radius than FA⁺ and MA⁺ cations (A-site), which could lead to instabilities and, subsequently, lattice collapse under compression.⁶⁸ This dual nature of ALD is represented as a free-energy diagram in Fig. S18 (ESI⁺).

Importantly, the ultrathin ALD layer also benefits device performances and long-term stability. The current densityvoltage curves (*J*–*V* curves) of the uncoated and ALD-0.75nm PSCs are depicted in Fig. 6a. A champion efficiency of 20.5% (19.1%) was achieved for ALD-0.75nm (uncoated) devices. Fig. S19 (ESI†) shows the statistics collected from 12 cells, respectively (refer to Table S1 for detailed photovoltaic parameters in the ESI†). The average short-circuit current density (*J*_{SC}) of the uncoated and ALD-0.75nm samples was unaffected and consistent with the external quantum efficiency (EQE) of the devices shown in Fig. S20 (ESI†).

Another effect of the possible surface passivation is an improvement in the fill factor (FF) to ~80% of the ALD-0.75nm, representing a ~3% absolute increment compared to the uncoated device. To further understand the electronic role of such an ultrathin ~0.75 nm ALD layer on the surface defects, we collected a map of the surface photovoltage value (SPV) distribution for both films, as shown in Fig. S21 (ESI†). The heterogeneous distribution of the SPV for the uncoated film suggests a non-uniform charge carrier density due to either the varied stoichiometry or non-uniform defect distribution.⁶⁹ Overall, the SPV value decreased from 65 mV with an RMS variation of 5 mV on the uncoated sample to 55 mV with an



Light

ALD-0.75nm

Glass/I

Glass/ITO

Humidity

Amorphous perovskite

Crystalline Perovskite



Fig. 6 (a) Champion J-V curves of the uncoated and ALD-0.75nm devices. The detailed parameters are listed in Table S1 (ESI†). (b) Normalized to 1 at the maximum power point (MPP) after 180 days of shelf-aging, The PSCs were kept for 1000 min under ambient conditions (>50% R.H. and 298 K) under 100 mW cm⁻² illumination and J-V measurements were performed every 10 min. (c) and (d): Long-term stability of ALD-0.75nm and control devices for ~2 months during outdoor MPPT measurements in Barcelona, Spain (41.50°N, 2.11°E). (c) Normalized power output (d) Normalized performance factor. Here, the performance factor is the ratio between the integral of total power produced vs. the integral of the total irradiance power on the device over one day.

RMS deviation of 3 mV on the ALD-0.75nm. The decrease of the SPV could be the result of the passivation of surface defect states, indicating improved homogeneity of the charge carriers and minimized surface defects.¹¹

Furthermore, we have also performed electrochemical impedance spectroscopy (EIS) of uncoated and ALD-0.75nm devices. The impedance characteristics of the PSC presented in Nyquist plots show two semicircles in two distinct frequency regions, which represent different processes in the device, shown in Fig. S22 (ESI[†]).⁷⁰ In the EIS response of the devices, the bulk recombination resistance (*R*2) is comparable with 3.0 k Ω and 3.2 k Ω for the ALD-0.75nm and uncoated devices, respectively. However, the interface recombination resistance (*R*3) increases from 2.3 k Ω for the uncoated device to 4.6 k Ω for the ALD-0.75nm device, indicating reduced recombination events at the interface. This is also consistent with the increase in the observed FF and V_{OC} of the ALD-0.75nm PSCs. The fitting parameters are shown in Table S2 (ESI[†]).

Fig. S23 (ESI[†]) indicates that the long-term shelf-stability of the unencapsulated ALD-0.75nm device can retain up to 85% of its initial power conversion efficiency (PCE) after 180 days of storage in an N₂ environment (<10% R.H.) while the ALDuncoated PSCs shows a 30% drop in the PCE. To intensify the impact of intense light and atmospheric degradation on the PSCs, these 180-day shelf-aged uncoated and ALD-0.75nm devices underwent MPPT aging in ambient atmosphere (>50% R.H.) for 1000 min, shown in Fig. 6b. All the derived photovoltaic parameters exhibited a more rapid decrease for the uncoated PSCs, as illustrated in Fig. S24 (ESI[†]). It is crucial to note that understanding the underlying reasons for performance degradation requires analysis of the final device performance and also other photovoltaic parameters (such as J_{SC} , V_{OC} , and FF). Therefore, we extracted the final J-V from each MPPT measurement point and plotted it in Fig. S25 (ESI[†]). Losses in FF and J_{SC} emerged as the dominant factors contributing to the decrease in the PCE of the uncoated devices. A significant improvement was observed in the ALD-0.75nm devices, maintaining up to 75% of the PCE before MPPT, along with comparatively stable V_{OC} and FF. It is evident that in both cases, the decrease in the final device performance of the PSCs is a function of J_{SC} and FF, and it declines for the uncoated PSCs.

As a figure of merit for greater device improvements, we performed outdoor device stability for the ALD-0.75nm vs. uncoated PSCs as per the ISOS-O-2 protocol in Barcelona, Spain (41.50°N, 2.11°E). Fig. 6c shows the normalized power output during the day and night cycles. The control device exhibits an exponential decline after 500 h, while the ALD-0.75nm device is stable until 1500 h, maintaining close to 98% of its initial PCE. To improve the outdoor comparison, we show the normalized performance factor (PF) of our devices in Fig. 6d, which is the ratio between the power produced and expected over one day, as used by Abate et al.⁷¹ Similar to the indoor MPPT shown in Fig. 6b, the performance of the ALD-0.75nm PSCs remained stable until 1500 h, three times higher than that of the uncoated device. The sudden drop in the performance for both the cells at around 500 and 1000 h is due to poor incident irradiance (in that particular period) and, accordingly, temperature as well as R.H. change, see Fig. S26 (ESI†). Notwithstanding, we observed that the ALD-0.75nm device showed better recovery after rainy days compared to the control.

These results indicate that the degradation of PSCs stems not only from poor charge transfer to the adjacent charge transport layer but also from poor charge generation within the active perovskite layer after shelf-aging and MPPT. Finally, the analysis performed here shows that a systematic study of the effect of individual layers under light-aging stress under ambient conditions can reveal multiple mechanisms of device degradation. Thus, we can infer that the presence of a ~ 0.75 nm thin layer of $\rm Al_2O_3$ acts as a barrier, enhancing long-term stability under ambient conditions.

Conclusions

In summary, our study focused on the long-term stability of PSCs, specifically examining the interaction between the perovskite material and the organic charge transport layer. To address these stability issues, we introduced an ultrathin Al₂O₃ (alumina) layer deposited via ALD at room temperature, ensuring that the underlying perovskite remained undamaged. Our findings indicated that the alumina layer functions as a dual-purpose diffusion barrier (against degassing) in addition to preventing moisture ingress into the perovskite. First, using nanoscale c-AFM, we demonstrated that the alumina conformally coats to the perovskite layers. This enhanced the contact of spiro-OMeTAD with perovskite while also acting as a defect-mitigating passivation layer. This improved the performance and intrinsic stability of the perovskite material. Secondly, the alumina barrier served as a protective layer impeding ion migration from the degraded spiro-OMeTAD into the perovskite and vice versa. Using a combination of spectroscopy, diffraction, and microscopy techniques, we showed that the alumina prevented the amorphization of crystalline perovskite, thereby enhancing the final device stability under ambient conditions, even without encapsulation. This study contributes to a holistic understanding of decoupling the final device degradation from the instability caused by ion migration from the perovskite material and by the residues from the degraded charge extraction layer into the perovskite. Hence, our study highlights the efficacy of a conformal diffusion barrier layer using an ultrathin alumina layer, deposited from ALD, in accelerating the commercialization and long-term durability of perovskite photovoltaics.

Experimental section

Materials

N,*N*-Dimethylformamide (DMF, 99.8%), dimethyl sulfoxide (DMSO, 99.9%), spiro-OMeTAD, 4-*tert*-butylpyridine (TBP), chlorobenzene (CB), lithium bis (trifluoromethylsulfonyl) imide salt (Li-TFSI), and cesium iodide (CSI, 99.9%) were purchased from Sigma-Aldrich Co., Ltd. Lead(π) iodide (PbI₂, 99.999%) and lead(π) bromide (PbBr₂, 99.999%) were purchased from TCI Chemical. Formamidinium iodide (FAI, 99.9%) and methylammonium bromide (MABr, 99.9%) were purchased from GreatCell Solar. The SnO₂ colloidal precursor (tin(π) oxide, 15% in H₂O colloidal dispersion) was purchased from Alfa Aesar. All salts and solvents were used as received without further purification.

Perovskite solutions preparation

The SnO_2 solution was prepared outside the glovebox by mixing 1 mL of SnO_2 colloidal precursor with 3 mL of deionized water. The prepared solution was mixed using a vortex shaker for 60 s

before use. The perovskite precursor and spiro-OMeTAD solutions were prepared in a nitrogen-filled glovebox. The perovskite solution was prepared by dissolving FAI (1.16 M), MABr (0.24 M), PbI₂ (1.19 M), and PbBr₂ (0.24 M) in a solvent mixture of DMF and DMSO in a 4:1 volume ratio. This "mixed" solution was stirred for 300 s until complete dissolution. A 1.5 M stock solution of CsI prepared in anhydrous DMSO was added to the "mixed" solution and filtered with a 0.25 µm PTFE filter to obtain the CsMAFA triple-cation, Cs_{0.05}(MA_{0.17}FA_{0.83})_{0.95}Pb(I_{0.83}Br_{0.17})₃. For the spiro-OMeTAD solution, 72.3 mg spiro-OMeTAD was dissolved in 1 mL chlorobenzene along, 28.8 µL 4-*tert*-butylpyridine (TBP) and 17.5 µL bis(trifluoromethylsulfonyl)imide lithium salt (Li-TFSI) solution (520 mg mL⁻¹ in acetonitrile). After constant stirring, the solution was filtered before use.

Device fabrication

Pre-patterned ITO substrates were cleaned sequentially with a detergent solution (2% Hellmanex in DI water), deionized water, acetone, and isopropanol for 15 min in an ultrasonic bath. After drying, the substrates were cleaned with ultraviolet ozone (UVO) for 15 min to remove organic residues. Next, the SnO₂ solution was spin-coated onto the cleaned ITO substrates at 3000 rpm for 30 s, followed by annealing at 150 °C for 30 min. The SnO₂ films were further cleaned by UVO treatment for 20 min and immediately transferred to the glovebox. The triple-cation perovskite precursor was spin-coated on the SnO₂/ ITO substrates at 1000 rpm for 10 s and 5000 rpm for 20 s. 150 µL of chlorobenzene was dropped at the last 5 s as an antisolvent. The substrate was then annealed at 100 °C for 30 min and allowed to cool before the next step. The samples were removed from the glovebox and transferred to the ALD system for Al₂O₃ deposition. After the ALD deposition, the samples were loaded in the glovebox again to deposit a spiro-OMeTAD layer at 4000 rpm for 20 s. Finally, gold was deposited using a 0.16 cm² area at a rate of 0.5 Å s⁻¹.

Atomic layer deposition of Al₂O₃

Atomic layer deposition was carried out in an SI PEALD system (SENTECH Instruments GmbH). The reactor walls and substrate heater were maintained at room temperature (RT). Trimethylaluminum (TMA, Dockweiler Chemicals, Electronic Grade) and water (VWR International, M-Clarity[™] = MQ1000) were used as the aluminium and oxygen sources, respectively. Both chemicals were kept in stainless steel bubblers at room temperature. Nitrogen (99.9999) was used as carrier gas with 120 sccm for both TMA and H_2O . The ALD cycle of Al_2O_3 comprises a 60 ms pulse of TMA, a 15 s N2 purge pulse, a 60 ms H₂O pulse, and a 15 s N₂ purge step. During deposition, the substrate temperatures of both processes were fixed at 25 °C. The perovskite samples were placed directly on an aluminum carrier, with a silicon reference piece in its vicinity. The film thickness was measured post-deposition on a silicon reference piece using a SENTECH spectroscopic ellipsometer SE 800. To assess the film thickness, a refractive index of 632.8 nm of 1.64 was assumed while applying the Cauchy model. To achieve a film thickness of ~ 0.75 nm, 14 ALD cycles

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were deployed, resulting in a growth rate of approximately 0.5 Å per cycle. For *in situ* ellipsometry, the total stack thickness consists of ~471 nm of perovskite and ~160 nm of ITO substrate plus silicate glass. Thus, the starting thickness reported was ~666.5 nm, including an average roughness of ~35.5 nm.

JV and EIS measurements

The *J*-*V* characteristics of the solar cells were recorded in an ambient atmosphere under an AM 1.5 G, 100 mW cm⁻² spectrum (WAVELABS, SINUS-70) using a Keithley 2400 source meter. The solar cells were unencapsulated during the test and measured in both forward and reverse directions using a 0.089 cm² mask from -0.2 V to 1.2 V with 200 mV s⁻¹ after 1 week of complete device fabrication. Impedance spectroscopy measures were performed using an Autolab potentiostat GSTT302N at short-circuit conditions with 10 mV AC voltage under dark in the frequency range of 0.01 Hz and 100 kHz.

MPPT tracking- long-term stability

For this measurement, a class AAA continuous solar simulator with a spatial uniformity in irradiance greater than 2% over the entire test area (156 mm \times 156 mm) was used under an irradiance of 100 mW cm $^{-2}$ with an AM1.5G spectrum, and the samples were placed on a controlled metal table at a temperature of (25 \pm 1) °C. An InfinityPV source measurement unit (SMU) was used to measure the IV curve and perform light-soaking degradation under MPPT conditions.

MPPT tracking- outdoor stability

Encapsulation sealing was performed using glass-to-glass sealing. First, the active area was covered with a UV-curing epoxy and then the top glass was placed and exposed to a UV light source (254 nm) for 45 min, and then copper wires were connected to the back contacts using conductive silver epoxy.

Outdoor stability (ISOS-O-2) tests were performed in Barcelona, Spain (41.30°N, 2.09°W, Csa climate). PSCs were mounted on a dual-axis sun tracker and performance was measured at MPP using an MP0205M24, LPVO maximum power point tracker. The solar intensity was measured with ISO 9060/IEC 61724 Class A pyranometers while the temperature was recorded using RK330-01 Atmospheric Temperature, Humidity & Pressure Sensors. All sensors were mounted on the same platform as the PSCs.

To calculate the performance factor, the output power density (P_{out}) from the device is integrated over a time interval of 1 day, and divided by the integrated input power density (P_{in}) from the measured solar irradiance over the same time of measurement. This is summarized in the following equation:

Performance factor =
$$\frac{\int_{t_1}^{t_2} P_{\text{out}} dt}{\int_{t_1}^{t_2} P_{\text{in}} dt} 1 \text{ day}$$

Electroluminescence (EL)

Electroluminescence (EL) images were captured using a siliconbased CCD camera (Hamamatsu ORCA-R2) without adding any additional optical filter to the lens. The electrical biasing of the samples under test has been conducted by using a digital DC Power Supply (Agilent E3642A)

EQE

The external quantum efficiency (EQE) of the solar cells was measured using an Enlitech QE-R system.

SEM

Surface topology images were obtained using a Hitachi S-4700 scanning electron microscope (SEM).

XRD

The XRD patterns were measured on an X"Pert Pro (PAN analytical) in Bragg–Brentano geometry using Cu K α 1 radiation (λ = 1.5406 Å) and scanning from 2° to 60° (2 θ) with a step interval of 0.0167°.

UV-vis

The absorption spectra were measured using a UV-Vis-NIR spectrophotometer (PERKIN ELMER, Lambda 1300).

XPS

Near-ambient-pressure (NAP) XPS measurements were performed on a custom-built spectrometer (Specs) using a DeviSim NAP reactor cell coupled with a differentially pumped hemispherical electron energy analyzer (Phoibos 150 NAP 2D-DLD) and Al K α X-ray source (μ -Focus 600). The samples were transferred to the NAP cell *via* ultra-high vacuum chambers with a base pressure of 1×10^{-9} mbar. During measurements, the samples were situated at a distance of 0.3 mm from an electron-collecting nozzle having an orifice diameter of 0.3 mm. The NAP cell operated in a dynamic mode with a completely open pumping outlet, while the required gas pressure was set using a proper gas inlet flow. Pure O₂ (Linde, purity 99.999%) and H₂O purified by several freeze–pump–thaw cycles were used in accelerated aging tests.

REELS is performed in an ESCALAB-150Xi (Thermo Fisher Scientific) with an electron beam source of 50 eV, both with a pass energy of 10 eV in a UHV environment below 10^{-8} Torr.

Conductive AFM/SPV

Conductive AFM and SPV measurements were performed using an MFP-3D infinity atomic force microscope (Asylum Research, Oxford Instruments) in a nitrogen-filled glove box, where the humidity and oxygen levels were below 0.4% and 0.1%, respectively. The measurements were performed with platinumiridium coated SCM PIT-V2 cantilevers (Bruker) with spring constants of 2 mN nm⁻¹ and a free resonance of 75 kHz. The cantilever holder for the conductive AFM measurement was an ORCA cantilever holder from Asylum Research with a current amplification factor of 2 nA N⁻¹.

The AlOx coverage was obtained using Gwyddion software. A mask on the current map by setting a data range as a percentage was set the maximum value of 100% was appointed and determined the minimum value by checking the covered area. Finally, we chose the lowest possible minimum range that covers the high-current areas but not the entire current map. For surface photovoltage (SPV) measurements, the sample was illuminated by a pulsed laser (Cobolt 06-01 Series) at 488 nm from below. Laser power was regulated by customwritten code embedded within the MFP3D control software by the AFM controller (Asylum Research ARC2), which supplied an analog voltage to activate the illumination. Surface photovoltage values were derived by subtracting the dark surface potential from the light surface potential.

TEM

For transmission electron microscopy (TEM), a lamella was prepared using the lift-out technique with a focused ion beam. The preparation was performed using a Zeiss Auriga Crossbeam Workstation. After selecting the area of interest, a protective platinum layer was deposited on the sample surface to protect the material near the surface from damage during the preparation. Then, the material was removed on both sides of the platinum layer using a gallium ion beam. The beam current of the gallium ions was reduced with a reduced thickness of the remaining material to avoid damaging the area of interest. When the lamella had a remaining thickness of approximately 1 μ m, it was cut loose and transferred to a TEM Grid with the aid of a micromanipulator. On the grid, the final thinning to electron transparency (typically less than 100 nm in thickness) was performed. The prepared lamella had a width of 16 μ m and a height of 8 μ m.

The TEM investigations were carried out in a Thermo Fisher Spectra 300 at 300 kV by bright-field imaging and selected area diffraction (SAD). The TEM was equipped with a highbrightness Schottky field-emission gun (X-FEG). The chemical composition was determined by spot measurements using energy-dispersive X-ray analysis (EDX). The TEM was equipped with a ThermoFisher Super-X EDX detector. The measurements were quantified using Velox software version 3.11. In addition, elemental distribution maps were recorded in the scanning TEM (STEM) mode with a pixel size of 150 pm and a dwell time of 4 μ s.

ToF-SIMS

Time-of-flight secondary ion mass spectrometry was performed using a ToF-SIMS5 from Iontof. In addition to analyzing the Bi source, we chose a Cs source for sputtering. With this source, we have the opportunity to detect electropositive and electronegative elements simultaneously by selecting CsClusters, such as CsPb⁺, CsSn⁺, or CsI⁺. Furthermore, the Cs cluster shows a reduced matrix effect compared to single Ions as Pb⁺ or Sn⁺. The analyzed area was in the size $20 \times 20 \ \mu\text{m}^2$, the sputter crater of the Cs source in the size of $300 \times 300 \ \mu\text{m}^2$.

Data availability

The data will be available upon reasonable request.

Conflicts of interest

There are no conflicts to declare.

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